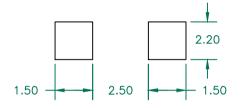
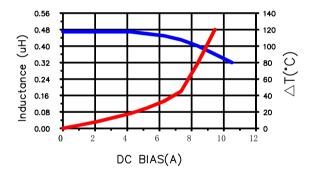
MGV0402R47M-10

PHYSICAL DIMENSIONS:

Α	4.50	<u>±</u>	0.50
В	4.10	\pm	0.30
С	2.00	±	0.30
D	1.50	\pm	0.30
Ε	1.00	\pm	0.50

LAND PATTERNS FOR REFLOW SOLDERING

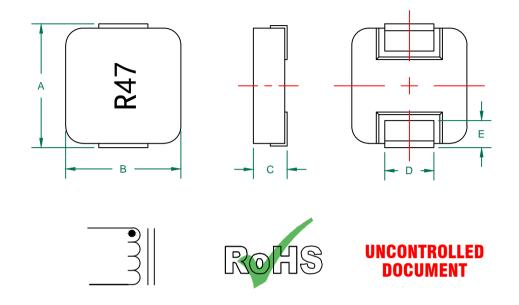




ELECTRICAL SPECIFICATION @ 25°C

	Min	Nom	Max
INDUCTANCE (uH) L @ 100 KHz/0.25V ± 20%	0.376	0.470	0.564
DCR (Ω)			0.014

Saturation Current ³ Isat (A)	9.50
Temperature Rise Current Irms ⁴ (A)	7.00



NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.SATURATION CURRENT Isat IS DEFINED AS MAXIMUM AMOUNT OF CURRENT BY WHICH INDUCTANCE WILL DROP BY TYPICAL VALUE OF 30% OF INITIAL INDUCTANCE (Ta=25±5°C).
- 4.TEMPERATURE RISE CURRENT (Irms): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta T \leq 40^{\circ}$ C) FROM 25°C AMBIENT.

[DIMENSIONS ARE IN mm.			This print is the property of Laird				
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ı					PROJECT/PART NUMBER:	REV	PART TY	PE:	DRAWN BY:
ı					MGV0402R47M-10	В		WER CTOR	QIU
ı	B	UPDATE LOGO	04/21/15	QIU	DATE: 02/19/13 SC	ALE: N	TS	SHEET:	
	Α	ORIGINAL DRAFT	02/19/13	QIU		OL #	13		
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